

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Confirmation No. 3064

Hiroaki INOUE et al.

Docket No. 2001 1094A

Serial No. 09/890,455

Filed August 1, 2001

ELECTROLESS PLATING LIQUID AND METHOD OF FORMING INTERCONNECTION USING SUCH AN ELECTROLESS PLATING LIQUID [Corresponding to PCT/JP00/09099 Filed December 21, 2000]

THE COMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE FEE FOR THIS PAPER TO DEPOSIT ACCOUNT NO. 23-0975.

PETITION FOR EXTENSION OF TIME

Assistant Commissioner for Patents, Washington, DC 20231 Sir:

Petition hereby is made for a two month extension of time to respond to the communication of November 26, 2001.

The fee of \$400.00 is

- (X) submitted herewith.
- to be charged to Deposit Account No. 23-0975. A duplicate copy of this Petition is enclosed.
- () Small entity status of this application is established by the verified statement under 37 CFR 1.9 and 1.27 which
 - () is enclosed.
 - () has been previously submitted.

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400.00 OP

Respectfully submitted, Hiroaki INOUE et al.

Bv

Warren M. Cheek, Jr. Registration No.33,367

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March 12, 2002